



JICTECH LCD (HONGKONG) CO.,LTD  
DONGGUAN JICTECH LCD CO.,LTD  
PROFESSIONAL LCM SUPPLIER

## DONG GUAN JICTECH LCD CO., LTD.

### Product Specification For TFT-LCD Module

Model No.: RT101TC16T-E03-V03

Specification Ver.: 01

APPROVAL FOR SPECIFICATIONS ONLY

APPROVAL FOR SPECIFICATIONS AND SAMPLE

CUSTOMER:	APPROVED BY:
DATE:	DATE:

If JICTECH samples are recognized by the customer, Please return 1 copy for your confirmation with your signature and comments. Thanks!

JICTECH LCM R&D CENTER		
APPROVED BY	CHECKED BY	PREPARED BY
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2021.12.29	2021.12.29	2021.12.29



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# 1. GENERAL SPECIFICATION

## 1.1 Introduction

The RT101TC16T-E03-V03 is a color active matrix Thin Film Transistor (TFT) Liquid Crystal Display (LCD) that uses amorphous silicon (a-Si) TFT as a switching device. This model is composed of a single 10.1 inches transmissive type main TFT-LCD panel. The resolution of the panel is 1024[RGB]x600 pixels and can display up to 16.7M color.

## 1.2 Feature

- Using TN panel and EWV polarizer. Ultra wide Angle of view.
- FOG and backlight assembly module.
- TTL RGB 24bit interface.

## 1.3 Application

- Display terminals for digital products. Industrial control Etc.

## 1.4 General Specification

No.	Item	Specification	Note
1	LCD Size	10.1" inch	-
2	Panel Type	a-Si TFT active matrix	-
3	Resolution	1024 RGB(H) x600(V) pixel	-
4	Display Mode	TN/ Normally White	-
5	Display Number of Colors	16.7M colors	-
6	Viewing Direction	12 clock	-
7	Contrast Ratio	800	-
8	Luminance	300 cd/m <sup>2</sup>	-
9	Module Size	235.0(W) x143.0(H) x7.30(T)mm	-
10	Active Area	222.72(W) x125.28(H)mm	-
11	Pixel Pitch	0.2175(W) x 0.2088(H)mm	-

12	LCM Driver IC	EK79007HJ3+EK73215	-
13	Light Source	6LEDs serial connection + 7parallel connection	-
14	Interface	TTL (RGB 24 BIT )	-
15	CTP Driver IC	ILI2511	-
16	CTP Interface	I2C	
17	Operating Temperature	-20~70°C (Max. scope)	
18	Storage Temperature	-30~80°C (Max. scope)	-
19	Weight	TBD g	-
20	CTP configuration file	Awoomedic_KP-101IB1202_V1.0 20211228.hex	-



### 3. ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
Operating temperature	Top	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max60 °C)	RH

### 4. ELECTRICAL CHARACTERISTICS

#### 4.1. DC Characteristics

Parameter of DC characteristics	Symbol	Min	Typ	Max	Unit
Supply voltage for logic	VDD	3.0	3.3	3.6	V
Input Current	Idd	-	13	-	mA
Input voltage 'H' level	VIH	0.7VDD	-	VDD	V
Input voltage 'L' level	VIL	VSS	-	0.3VDD	V
Output voltage 'H' level	VOH	VDD-0.4	-	VDD	V
Output voltage 'L' level	VOL	VSS	-	VSS+0.4	V

#### 4.2. Backlight Characteristics

Item of backlight characteristics	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward voltage		17.4	19.2	20.4	V	If=140mA
Number of LED	-	-	42	-	Chips	-
LED circuit	6LEDs serial connection + 7parallel connection					
Chromaticity	x	0.25	-	0.35	-	If=140mA
White CIE (x, y)	y	0.25	-	0.35	-	

Using condition: constant current driving method  $I_f=20\text{mA}(+/-10\%)$ .

## 5. INTERFACE DESCRIPTION

### 5.1. LCM PORT:

1-2	NC	-	No connect	
3-4	NC	-	No connect	
5	GND		ground	
6	VCOM		Common voltage	
7	VDD		Power supply for analog circuit, 3.3V	
8	MODE		DE or HV mode control	
9	DEN	I	Data input Enable. Active High to enable the data input Bus under “DE Mode”.	
10	VSYNC	I	Vertical Sync input. Negative polarity.	
11	HSYNC	I	Horizontal Sync input. Negative polarity.	
12-19	B7-B0	I/O	8-bit digital Blue data input.	
20-27	G7-G0	I/O	8-bit digital Green data input.	
28-35	R7-R0	I/O	8-bit digital Red data input.	
36	GND		ground	
37	DOTCLK	I	Clock signal. Latching data at the rising edge.	
38	GND		ground	
39	L/R		Left/ Right selection	
40	U/D		Up/Down selection	
41	VGH		Gate on voltage	
42	VGL		Gate off voltage	
43	AVDD		Power analog circuit	
44	RESET		Global reset pin	
45	NC	-	No connect	
46	VCOM		Common voltage	
47	DITHB		Dithering function	
48	GND		System ground	
49-50	NC	-	No connect	

CTP PIN SYMBOL(I2C)				
1	SDA		I2C data input and output	
2	SCL		I2C clock input	
3	RESET		External Reset, Low is active	
4	INT		Interrupt request to the host, or Wakeup request from the host.	
5	GND		Power 0v	
6	VDD 3.3V		digital power supply,	

Note: The voltage power of the interface logic pin depend on “IOVCC” and “GND”.

## 6. ELECTRO-OPTICAL CHARACTERISTICS

Item of electro-optical characteristics	Symbol	Condition	Min	Typ	Max	Unit	Remark	
Contrast ratio	CR	Viewing normal angle	-	800	-	-	Note 1	
Surface Luminance	Lv	$\theta = \phi = 0^\circ$	260	300	360	Cd/m <sup>2</sup>	Note 2	
Luminance uniformity	$\delta$ WHITE	If=140mA	80		-	%	Note 3	
Response time	Tr+Tf	TC=25°C	-	15	24	ms	Note 4	
Viewing angle range	$\theta$	Center (CR $\geq$ 10)	3:00	60	-	degree	Note 5	
			9:00	60	-			
			6:00	50	-			
			12:00	65	-			
Module Chromaticity CIE (x, y)	White	Viewing normal angle $\theta = \phi = 0^\circ$	x	0.245	-	0.345	-	Note6
			y	0.245	-	0.345		
	Red		x	0.554	-	0.614		
			y	0.241	-	0.341		
	Green		x	0.241	-	0.341		
			y	0.489	-	0.589		
	Blue		x	0.067	-	0.167		
			y	0.054	-	0.154		
NTSC Ratio	S	-	-	70%	-	-	Note7	

\*Note: All above side data are based on JICTECH following condition.

Note1. Contrast Ratio (CR) is defined mathematically by the following formula. For more information see FIG 1.

$$\text{Contrast Ratio} = \frac{\text{Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}{\text{Average Surface Luminance with all black pixels (P1, P2, P3, P4, P5)}}$$

Note2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 1.

$$L_v = \text{Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}$$

Note3. The uniformity in surface luminance ( $\delta$  WHITE) is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 1.

$$\delta \text{ WHITE} = \frac{\text{Minimum Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}{\text{Maximum Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}$$

Note4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 2.

Note5. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note6. CIE (x, y) chromaticity ,The x,y value is determined by screen active area position 5. For more information see FIG 1.

Note7: NTSC ratio : For more information see FIG 4.

$$\text{NTSC ratio} = \frac{\text{Area of RGB triangle}}{\text{Area of NTSC triangle}}$$

Note8. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE , the testing data is base on BM-7 photo detector.

Note9. For TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle

FIG.1. Measuring method for Contrast ratio,surface luminance, Luminance uniformity,CIE (x,y) chromaticity

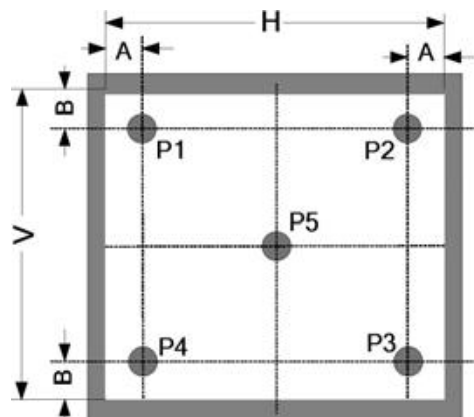
A : 5 mm

B : 5 mm

H,V : Active Area

Light spot size =5mm, 500mm distance from the LCD surface to detector lens

measurement instrument is luminance meter BM-7.



or DMS 803.

FIG. 2. The definition of Response Time

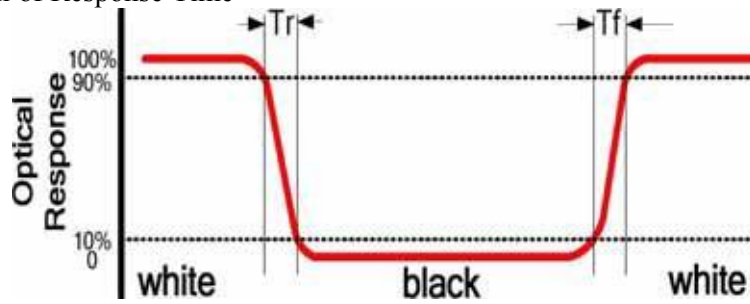


FIG. 3. The definition of viewing angle

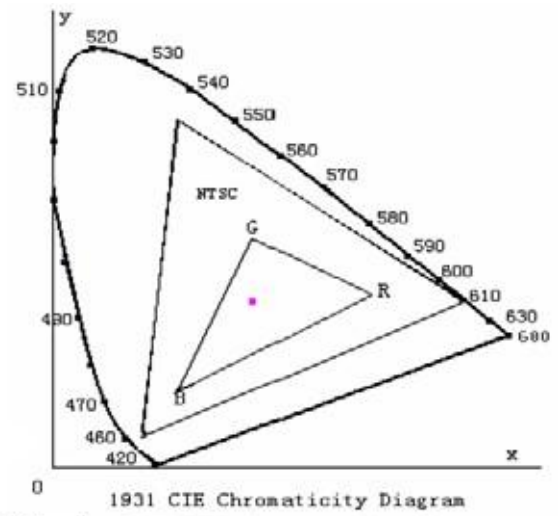
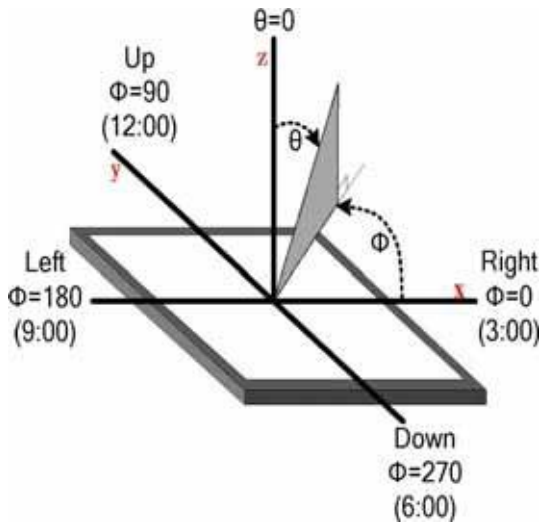


Fig.4. 1931 CIE chromaticity diagram

## 7. RELIABILITY TEST CONDITIONS

	No.	Test Item	Content of Test	Test Condition
Environment Test	1	High Temperature Storage	Endurance test of high temperature for a long time.	80±2°C 48H
	2	Low Temperature Storage	Endurance test of low temperature for a long time.	-30±2°C 48H
	3	High Temperature Operation	Endurance test of electrical stress (Voltage & Current) and the thermal stress to the element.	70±2°C 48H
	4	Low Temperature Operation	Endurance test of electrical stress (Voltage & Current) and the thermal stress to the element.	-20±2°C 48H
	5	Thermal shock	Endurance test of low and high temperature cycles.(air to air)	-20±2°C,(30min) )-25±2°C,(30min) in)/+70(30min) ±2°C.10 cycle

**Note:**

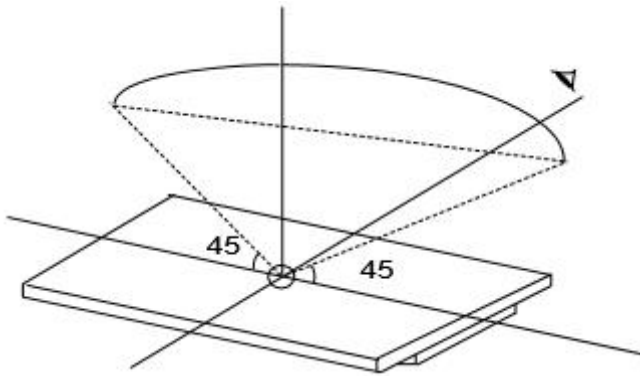
- 1) When making the low temperature test, not to dewy.
- 2) Driving condition for operation test.Power Supply Voltage for Logic System Failure Judgment Criterion After the above mentioned test.( For Environmental Test, after 2 hours in room temperature.) There should not be conspicuous failure of display quality and appearance.
- 3) Contrast ratio should be 50% of the initial contrast ratio.
- 4) There should not have any abnormality of function.

## LIFE TIME

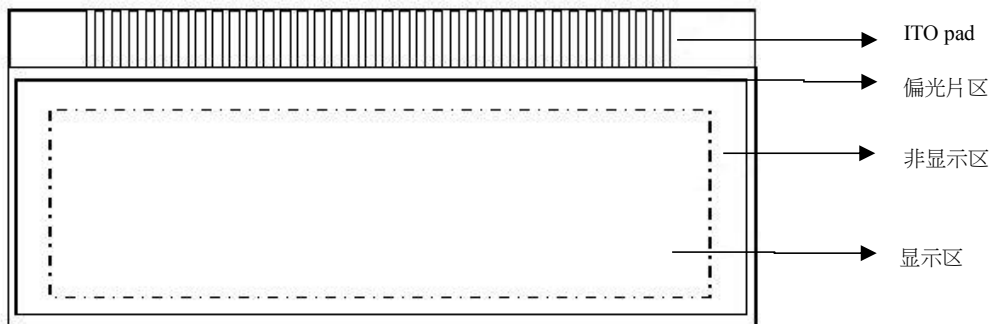
Item	Description
1.	Functions, Performance, appearance, etc. shall be free from remarkable deterioration within 30,000 hours under ordinary operating and storage conditions room temperature (25±10°C) , normal humidity(40±20%RH),and in area not exposed to direct sun light.

## 8.INSPECTION CRITERIA

1. The sampling plan and scheme  
MIL-STD-105E,General II level standard single sampling inspection level
2. Acceptable standards (AQL)  
main defects(MAJ) : 0.65  
minor defects(MIN) : 1.5
3. Test conditions and method
  - 3.1. Temperature  $25\text{ }^{\circ}\text{C} \pm 5\text{ }^{\circ}\text{C}$  ,humidity  $45 \pm 20\%$  ,enough light (40W fluorescent lamp,about 40cm),the sightdistance is 30cm
  - 3.2.  $0^{\circ}\sim 45^{\circ}$ left and right  $45^{\circ}$  , upper and bottom  $0^{\circ}\sim 45^{\circ}$



### 3.3. Area definition



- 3.4. Intensive definition: there are less than two points or two lines within  $10\text{mm}^2$ , known as dense.
- 3.5. If the standards, specifications is not consistent with technical requirements,the product data sheet shall be prevailed
- 3.6. For the LCD that more than 80pcs /tool ,use A standard if customers have special requirements  
Distance between unqualified points $\geq 5\text{mm}$

## 8.1 Classification of defects

The main defects (MAJ): the product has lost its function or can't reach the specification requirements in terms of performance parameters, or because of the size of the problem caused by the inability to assemble.

Slight defects (MIN): appearance can't meet the standard requirements, but no other effects

- 3.7. Test voltage, refer the usage requirements of jig set and the product design requirements, compare with approval sample
  - 3.7.1. By default, LCD voltage external can be adjusted,the standard performance and voltage are controlled as below:when LCD driver voltage  $\leq 5\text{V}$ ,controlled as  $\pm 0.2\text{V}$ ,when LCD driver voltage  $> 5\text{V}$ ,controlled as  $\pm 0.3\text{V}$ ,for


COG type,if the VOP is lower than 10V,controlled as  $\pm 0.2V$ ,if VOP is higher than 10V,controlled  $\pm 0.3V$ .

3.7.2. Customers have special requirements for fixed voltage products, the internal circuit adjustment to ensure that the display effect, and if necessary, develop a lower limit of the sample

## 8.2 Defect items and acceptance standards

Mechanical size: to meet technical specifications drawings, according to the main defect judgment

### Electrical properties

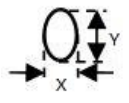
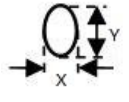
NO.	Items	Description	Acceptance criteria	Defect grade
3.7.3.	Missing segment	Horizontal / vertical missing segment,lack of icons, lack of stroke	NG	MAJ
3.7.4.	No display, no action	No display in normal connection	NG	MAJ
3.7.5.	Display error, abnormal display	According to the normal scanning program, the ICON is inconsistent with order and requirements or displayed randomly	NG	MAJ
3.7.6.	Wrong angle view	The angle view is inconsistent with the design requirements (or samples)	NG	MAJ
3.7.7.	Contrast depth	Under normal display, the overall contrast is too deep or slight, and the voltage deviation exceeds the standard	Refer to the 4.9.1 item voltage standard control	MAJ
3.7.8.	Cross Talk	Display crosstalk shall not exceed limit sample	Reference limit sample	MAJ
3.7.9.	Extra display	Display icons, strokes, rows, columns, lines, etc. that should not be displayed at work	Reference dot and line standard	MIN
3.7.10	PI dot	Local black spots or white spots appear when change image	Pause screen visible, reference point, line standard, reference sample during changing image	MIN
NO.	Items	Description	Acceptance criteria	Defect grade
3.7.11	Pinhole and bumps defect 	At work, the pattern is incomplete or out of shape	Reference dot and line standard	MIN

 $d=(X+Y)/2$			
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## LCD appearance

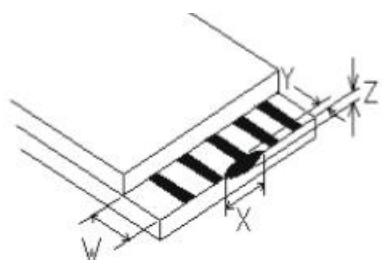
Dot, line (just for V.A area control)

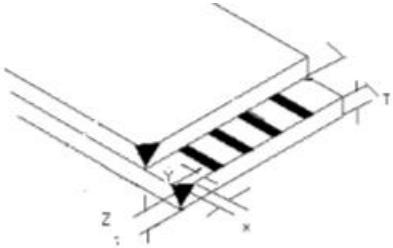
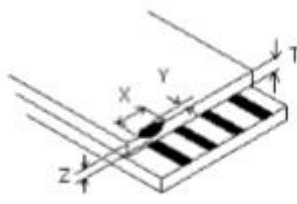
3.7.12.

Item	size(mm)	QTY'				Defect grade
		A+级	A 级	A1 级	A2 级	
Spot (black dot, sundries, stab, scratch)  $d=(X+Y)/2$	$d \leq 0.15$	1	2	3	3	MIN
	$d \leq 0.20$	0	1	3	3	
	$0.20 < d \leq 0.25$	0	0	1	2	
	$0.25 < d \leq 0.30$	0	0	0	1	
	$0.30 < d$	0	0	0	0	
Polarizer bubble  $d=(X+Y)/2$	$d \leq 0.15$	1	2	3	3	MIN
	$0.30 < d \leq 0.20$	0	1	2	2	
	$0.50 < d \leq 0.30$	0	0	0	1	
	$0.80 < d$	0	0	0	0	
Line (black line, white line, debris, stab, scratches, water wave) $L \leq 2.00, W \leq 0.02$ $L \leq 2.00, W \leq 0.03$ $L \leq 3.00, W \leq 0.05$ $L \leq 3.00, W \leq 0.10$	$L \leq 2.00, W \leq 0.02$	1	1	2	3	MIN
	$L \leq 2.00, W \leq 0.03$	0	1	2	3	
	$L \leq 3.00, W \leq 0.05$	0	0	0	1	
	$L \leq 3.00, W \leq 0.10$	0	0	0	0	

LCD broken and crack, (aim at the product that without bezel and the LCD corner directly exposed including COG, heat seal connector (FPC), LCD+BL type, and the product with bezel, if it won't affect the function and reliability after assembly or the breakage and crack covered by bezel, it can be acceptable, L is the length of the breakage side, W is the width of ITO, T is the thickness for single LCD, H is the width together with plastic frame)

3.7.13.

Item	Acceptable criteria					Defect grade
	(mm)	A+级	A 级	A1 级	A2 级	
Conductive foot position crack 	X	$\leq 2.0$	$\leq 3.0$	$\leq 1/8L$	$\leq 1/6L$	MIN
	Y	$\leq 1/5W$	$\leq 1/4W$	$\leq 1/4W$	$\leq 1/3W$	
	Z	$\leq 1/2t$	$\leq 1/2t$	$\leq t$	$\leq t$	
	acceptable QTY'	1	1	2	2	
	When $Y \leq 0.2\text{mm}$ , X length can be ignored, when non conductive surface cracked and not thoroughly crack,					

	according to $X \leq 1/8L$ , $Y \leq 1/2W$ or $X \leq 3\text{mm}$ , $Y \leq W$						
corner crack (ITO pin) 	X			$\leq 1/10L$	not enter the inner border, the area touched Conduction potential is less than 1/4.	MIN	
	Y	$X+Y \leq 2.0$	$X+Y \leq 3.5$	$\leq 2/3W$			
	Z	$\leq t$	$\leq t$	$\leq t$			$\leq t$
	acceptable QTY'	1	1	2			2
Item	Acceptable criteria					Defect grade	
Sealing surface collapse (external collapse) 	X	$\leq 2.0$	$\leq 1/10L$	$\leq 1/8L$	$\leq 1/8L$	MIN	
	Y	$\leq 1/2H$	invisible in VA area	invisible in VA area	invisible in VA area		
	Z	$\leq t$	$\leq t$	$\leq t$	$\leq t$		
	acceptable QTY'	1	1	2	2		
	For breakage between glass, if breakage cause conduction point or frame glue exposed more than 1/3: NG						
Convex glass, cutting defect, burrs, W, is ITO width	X	$\leq 2.0$	$\leq 3.0$	$\leq 3.0$	$\leq 5.0$	MIN	
	Y	$\leq 1/5W$	$\leq 1/6W$	$\leq 1/5W$	$\leq 1/4H$		
	Z	/	/	/	/		
	acceptable QTY'	1	1	1	2		
	The for the burrs, controlled according to the specifications of dimension tolerances						
fissure	non-directional and progressive cracks is not allowed. The fissure in the interior is NG and the fissure outward is acceptable(refer to the breakage criteria)					MAJ	

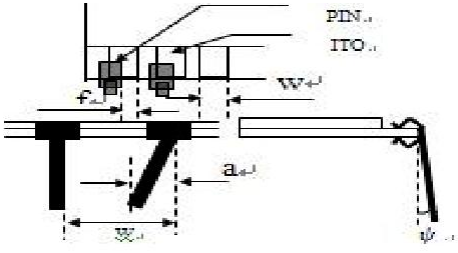
## Polarizer

Items	Description	Acceptance criteria	Defect grade
-------	-------------	---------------------	--------------

Slice oblique / serrated	Polarizer does not cover frame lines, or over tolerances	1. non-ITO pad area can be cut 2. in general, A1, A2, A3 are controlled by tolerances for polarizer attaching, A0, A* controlled by vertical view until can observe black edge	MIN
water wave	To observe wave water phenomenon on the polarizer surface against the light	Refer to sample	MIN
The protective film is difficult to tear, fall off and tilt	/	1. for peel off tape, if 3 times can bring up protective film, it's qualified. 2. the protective film on LCD front can't be tilted, obvious dirt or polarizer dirt can't be allowed 3., the protection film tilting will affect COG/FOG crimping, all reject 4. do not allow the protective film to fall off	MIN
Polarizer is attached to the reverse	The angle is reversed and the bottom or surface is reversed	rejection	MAJ
contamination	polarizer contamination	obvious contamination is not allowed	MIN
direction	the range of angle view, background difference	Refer to the sample and keep in line with the same batch	MIN
bubble, concave-convex dot	There is air or bubbles caused by ink between polarizer and glass	for concave-convex dot, need to refer to sample	MIN

## Other inspection items

Items	Description	Acceptance criteria	Defect grade
Rainbow	1pcs product with two or more colors	refer to sample	MIN
Leakage	Vacuum bubble, sealing is not full, liquid crystal is not filled, etc.	NG	MAJ
Protective film	There is no protective film on the polarizer, and obvious contamination on the surface is not allowed	NG	MIN
PIN part no and	the part no, specifications, length, span, angle, shape for PIN foot should be consistent with	NG	MAJ

spec	drawing		
Appearance	The PIN QTY' can't match, poor contact; sealed and UV glue on ITO is not completely cured, without sealing glue.	NG	MAJ
	PIN glue leakage,glue breakage,glue exceeds LCD,glue exceeds polarizer,If customer request special, the amount of glue should be judged as a serious defect	NG	MIN
	there is glue on PIN , PIN loose, deformed, skewed, and oxidized	NG	MIN
Peel-off tape	Missing attach, wrong position, crooked, peel off tape can not peel off protective film	NG	MIN
Identification and marking	already requested add Identification and marking on protection film or LCD footstep	The content is consistent with the requirement	MIN
		If the code can be identified at once, it is judged to be qualified	
Surface silk printing	After make silk printing, attach polarizer on LCD surface,observe there are Linear bubble phenomenon	refer to sample	MIN
PIN position	 <p>f=PIN 错位宽度 shift width , w=ITO pad 宽度 width</p>	PIN crooked : $a \leq 1/3w$ , $\psi \leq \pm 5^\circ$	MIN

## Back-light

NO.	Items	Description	Acceptance criteria	Defect grade
3.7.14.	LED no display,w rong color	LED no display, the color is not consistent with the sample or specifications	NG	MAJ
3.7.15.	color difference	it's different with sample when display,and also different with drawing after measuring	NG	MIN
3.7.16.	Luminance difference	the luminance is different with sample when display and different with drawing also after	If the deviation of the specifications is not indicated on the	MIN

	e	measuring	drawings, it shall be controlled according to the range of $\pm 15\%$ of the brightness for sample	
3.7.17.	Nonuniform	the uniformity is different with spec when display	if it's out of spec, reject, the uniformity that don't request on drawing should controlled as more than 75%	MIN
3.7.18.	Scratch	it happen contamination .scratch ,dot and line defect when display	Refer to dot and line standard	MIN
3.7.19.	Flicker	flicker phenomenon can't be allowed when display	NG	MAJ
3.7.20.	B/L perk	PCB B/L must be very close to attach with PCB B/L	Backlight tilt no more than 0.5mm is allowed	MIN
3.7.21.	Components taken off	the components on light guide is taken off	NG	MAJ
3.7.22.	Date code	The code is inconsistent with the sample or drawing	NG	MIN

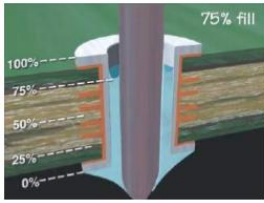
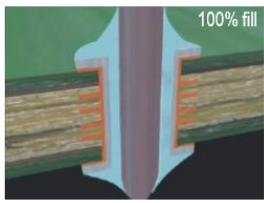
## PCB/PCBA

NO.	Items	Description	Acceptance criteria	Defect grade
3.7.23.	Glue sealing defect	1) there is a bonding line in the round white mark, the circuit is exposed or the soldering plate is exposed more than 1 places; 2) the height of sealing glue exceeds the requirement of spec; (no special requirement is controlled by 1.5mm) 3) the sealing glue shall be in the white mark, the maximum shall not exceed the mark radius outside 2mm; 4) there is obvious linear traces on the glue surface, and the pinholes penetrate through the wafers; 5) the needle hole diameter of the	reject	MIN

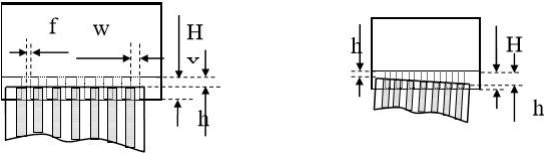
NO.	Items	Description	Acceptance criteria	Defect grade
		glue surface >0.25mm and has extra objects; 6) glue permeates to the opposite side of PCB		
3.7.24.	PCB appearance	1) the surface of gold plate is oxidized or with dirt 2) gold is not golden, bright 2)there is bubbles after reflow soldering 3) warping and perking 4) green pitting, oxidation, corrosion	reject	MIN
		Green oil is faded,scratch or expose copper	Green oil pen repair. The diameter is 1.3mm on the line, and the diameter on the non-line is 2.6mm, allowing 10 places.	
		Glue area with glue	diameter≤2.0mm,2pcs allowed	
		Silk color,oil color,silk content,silk form	sample	MIN
3.7.25.	Components error or missing	The components on the PCBA is not consistent with BOM. The direction is wrong and the polarity is the opposite	NG	MAJ
3.7.26.	Part no	part no or version is different with spec	reject	MAJ

## SMT/SOLDERING

NO.	Items	Description	Acceptance criteria	Defect grade
3.7.27.	Soldering defect	1)cold welding, false welding, missing welding , cracking of tin, tin is not dissolved etc.; 2) non welding area with tin ball or tin slag	NG	MAJ
3.7.28.	DIP device	DIP devices, buttons, connectors and other devices are floating high and skew	NG	MIN
3.7.29.	The shape of	The soldering point shall be recessed and shall be not allowed excess solder and inadequate	acceptable	MIN

	soldering point	tin and tin tip etc.		
3.7.30.	Components foot exposed	for the plug type welding device, after soldering, cut off the foot	The height should be controlled in 0.5mm~2.0mm, cannot hurt the tin ball surface and excess welding cause device foot disappear	MIN
NO.	Items	Description	Acceptance criteria	Defect grade
3.7.31.	The tin on the soldering vias is not reasonable	Metal soldering vias, solder joints, minimum tin penetration shall not exceed 25% of the plate thickness (i.e., the tin content is not less than 75% of the plate thickness as picture 1); the required pore size of the particular product shall be 100% filled, as shown in Figure 2  图 1  图 2	general, the tin content is not less than 75% of the plate thickness, and the special requirement is that the product exceeds 100% of the tin content	MIN
3.7.32.	Appearance defect	The residual rosin is yellowish brown or charred	NG	MIN
3.7.33.	Welding pinhole	happen spot Blowhole during welding process	$D \leq 0.2\text{mm}$ , 1pcs allowed	MIN

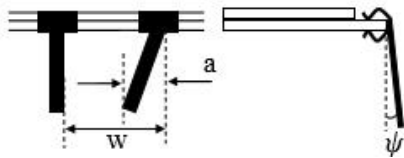
## Hot seal

NO.	Items	Description	Acceptance criteria	Defect grade
3.7.34.	part no and spec	Specifications for Zebra paper, FPC, etc.	Refer to the BOM sheet or drawings	MAJ
3.7.35.	dimension and position	The size of heat pressing material should be within the range of drawing specification 	$f \leq 1/3W, h \leq 1/4H$ , And meet the drawing size requirements	MIN
3.7.36.	objects happen	The foreign objects in the heat pressing area, and it is not in the open position ,can not cause	acceptable	MIN

	d during heat pressing	short circuit; the foreign objects is smaller than the 50% pressing area		
3.7.37.	fold trail	FPC or zebra paper fold to damage is not allowed	NG	MIN
3.7.38.	FPC 外观	scratches, breakage, gold plate oxidized, stains	refer to sample	MIN

NO.	Items	Description	Acceptance criteria	Defect grade
3.7.39.	burrs	FPC with convex or concave in the edge	不伤及线路情况下 $\leq 2.0\text{mm}$ 控制 In the case without damaging the circuit controlled as $\leq 2.0\text{mm}$	MIN

## Connector and other parts

NO.	Items	Description	Acceptance criteria	Defect grade
3.7.40.	part no/spec	The part no / specification must meet BOM list and design requirements, and the position shall be within the drawing specification	acceptable	MAJ
3.7.41.	position	Welding reverse	NG	MAJ
3.7.42.	order	The order of the first PIN and the PIN shall be consistent with the specifications of the product drawings	acceptable	MIN
3.7.43.	contamination	External device and PIN foot are stained with solder flux, and the sealing glue shall not be attached to the PIN end of the connector	NG	MIN
3.7.44.	PIN out of shape	<p>PIN connector, PIN bending, skew phenomenon</p> 	<p>1) Pin out of shape is no more than 1/3 PIN thickness (if with socket, must guarantee connection well), can't allow PIN bent and bottom layer leakage</p> <p>2) PIN shift, <math>a \leq w/3</math>, <math>\psi \leq 5^\circ</math>, don't affect assembly, acceptable</p>	MIN
3.7.45.	PIN oxidation	PIN oxidation	NG	MIN
3.7.46.	The via	Plug type connectors are not allowed to have a	NG	MIN

	hole are blocked	hole to plug the deformation phenomenon; with the latch of the lock should be able to tie the external connector lock (the matching pin to ensure that the matching plug and lock good)		
3.7.47.	others	Other additional parts shall be consistent with drawings and technical requirements	if not affect function,pass	MIN

## LCM APPEARANCE

NO.	Items	Description	Acceptance criteria	Defect grade
3.7.48.	the appearance of connect or material	FPC, gold plate or zebra paper, the FPC end that connect with LCD or PIN exposed copper or leaking substrate; There are breakage, stain, or FPC, FFC, COF, zebra paper and other peripheral materials already fold to almost damaged (except original design); FPC, PCB gold plate with a sticky tin greater than 2/3PIN wide; FPC, FFC and other material stab, fold trail exceeds limited sample	NG	MIN
3.7.49.	补强带不良	The adhesive tape must be completely covered and the protect circuits (such as zebra paper, FFC, FPC, etc.) can't exceed PIN area, and the black tape at the IC position shall be able to effectively shade the IC position	acceptable	MIN

NO.	Items	Description	Acceptance criteria	Defect grade
3.7.50.	reinforcing board or glue	After heat pressing, attach strong adhesive tape or play reinforcing glue according to technical specifications to protect all circuits, missing attachment is not allowed and must keep surface flat	acceptable	MIN
3.7.51.	appearance stain	the labels or marks of rework product are not clean well, obvious stains (dust, finger prints), residual glue, etc.	In general, the batch of stains can not be acceptable normally	MIN
3.7.52.	assembly objects	the contamination (like dot or line) caused by B/L or diffusion	refer to dot/line standard	MIN
3.7.53.	three proof	For the products that need three proof paint, the painting position must be correct, the pin	NG	MIN

	pain	and the test position, the gold plate can not be painted, the special location can not be exposed, and the thickness meets the design requirements		
3.7.54.	product identification	part no and batch No (including Stickers / silk screen / inkjet) should be consistent with the requirements of the document, not blurred, leakage, paste, leak spray, bar code scanning defect	NG	MIN
3.7.55.	Component identification	The component mark is not clear, the measurement value is consistent with the document request	allowed	MIN
3.7.56.	Breakage of electronic components	components with hiatus or broken	NG	MAJ
3.7.57.	assembly position	after assembly, upper and bottom , left and right of LCD shift and overall shift	refer to drawing and sample	MIN
3.7.58.	mixed materials	The same batch of products mixed with different part no	NG	MAJ

NO.	Items	Description	Acceptance criteria	Defect grade
3.7.59.	TP assembly objects	there is TP assembly objects like fog shape	if it's invisible when display, pass it, others refer to dot/line standard	MIN
3.7.60.	Socket or pin skew	upper and bottom , left and right shift	refer to drawing tolerance or sample	MIN
3.7.61.	glue sealing defect	PIN glue exceeds polarizer 2) IC bonding glue with the hole that inner circuit or IC can be visible	NG	MIN
3.7.62.	overall structure	The overall mechanism assembly must be consistent with the assembly drawings	1) assembly skew, shift, (light guide LCD, TP, etc.), NG 2) bezel out of shape need to refer to limit sample	MIN

3.7.63.	PIN heated to injure	In the process of welding ,pin is heated to injure	if it cause PIN not in a line,reject	MIN
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## PACKAGING

NO.	Items	Description	Acceptance criteria	Defect grade
3.7.64.	Identification error	the par no on the label, order number, date code is not consistent with each other	NG	MAJ
3.7.65.	shortage	The QTY' of identification is not consistent with actual QTY'	NG	MAJ
3.7.66.	Package safety compliance	Packing meets ocean transportation requirements, anti-static, moisture-proof and so on	NG	MAJ

## Others

If there are items that not be stipulated and concessions to release, subject to the agreement and the limit of the sample

## 9.0 PRECAUTION FOR USE OF LCD MODULE

### 9.1 Handling Precautions

- 1) The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 2) If the display panel is damaged and the liquid crystal substance inside it leaks out ,be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. 5) If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:  
--Isopropyl alcohol 异丙醇  
--Ethyl alcohol 酒精  
Solvents other than those mentioned above may damage the polarizer.  
Especially, do not use the following:  
--Water 水  
--Ketone 芳香剂
- 6) Do not attempt to disassemble or process the LCD module.

## 9.2. Assembling Precautions

- 1) When mounting the LCD module make sure that it is free of twisting, warping, and distortion. Distortion has great influence upon display quality. Also keep the stiffness enough regarding the outer case.
- 2) Please handle the LCD module by its side.
- 3) NC terminal should be open. Do not connect anything.
- 4) If the logic circuit power is OFF, do not apply the input signals.
- 5) To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - Be sure to ground the body when handling the LCD module.
  - Tools required for assembly, such as soldering irons, must be properly grounded.
    - To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
    - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- LCD
- 6) Be careful when treating the glass panel because it has very sharpened edge.

## 9.3 Storage Precautions

- 1) When storing the LCD module, avoid exposure to direct sunlight or to the light of fluorescent lamps and high temperature/high humidity. Whenever possible, the LCD module should be stored in the same conditions in which they were shipped from our company.
- 2) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets or a current flow in a high-humidity environment.

## 9.4 Design Precautions

The absolute maximum ratings represent the rated value beyond which LCD module can not

- 1) exceed. When the LCD modules are used in excess of this rated value, their operation characteristics may be adversely affected.
- 2) To prevent the occurrence of erroneous operation caused by noise, attention must be paid to satisfy VIL, VIH specification values including taking the precaution of using signal cables that are short.
- 3) The LCD exhibits temperature dependency characteristics. Since recognition of the display becomes difficult when the LCD is used outside its designated operating temperature range, be sure to use the LCD within this range. Also keep in mind that the LCD driving voltage levels necessary for clear displays will vary according to temperature.
- 4) We recommended that power supply lines (VDD) have over-current protection line. (Fuse etc. Recommend Value:0.5A)
- 5) Sufficiently notice the mutual noise interference occurred by peripheral devices.
- 6) To cope with EMI, take measures basically on outputting side.
- 7) When installing an LCD module, fasten it at the LCD panel.
- 8) The display panel is made of general float glass which is not guaranteed for strength. So please consider about following.

- Do not subject panel to a mechanical shock by dropping directly.
- Do not let case to touch to panel directly.

#### Others

- 1) Liquid crystal solidifies under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the LCD module is subjected to a strong shock at a low temperature.
- 2) If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3) To minimize the performance degradation of the LCD module's resulting from destruction caused by static electricity, etc., exercise care to avoid touching the following section when handling this module:  
LCD's Terminal electrode sections.
- 4) Optimum voltage to obtain best contrast value depending on products. Therefore voltage adjustment with electric volume is required in each display.
- 5) Precaution for disposal of LCD module. When disposal of LCD module, ask specialization company of industrial waste which is permitted by the government. When burn up LCD module, obey the law of environmental hygienics.